

DECLARATION

As below named inventor, I hereby declare that:

My residence, post office address and citizenship is as stated below next to my name.

The below named inventor is the original, first and joint inventors of the subject matter which is claimed and for which a patent is sought on the invention entitled, **SYSTEM, METHOD AND APPARATUS FOR FORMATTING INVENTORY DATA**, the Specification of which:

 X is attached hereto.
 was filed on _____, as Application Serial No. _____.

I hereby state that I have reviewed and understand the contents of the above-identified specification, including the claims.

I acknowledge the duty to disclose to the Patent and Trademark Office all information known to me to be material to patentability of the subject matter claimed in this application, as "materiality" is defined in Title 37, Code of Federal Regulations, § 1.56.

I hereby claim foreign priority benefits under Title 35, United States Code, § 119 of any foreign application(s) for patent or inventor's certificate listed below and have also identified below any foreign application for patent or inventor's certificate having a filing date before that of the application on which priority is claimed:

NONE

I hereby claim the benefit under 35 U.S.C. §119(e) of any United States provisional application(s) listed below:

NONE

I hereby claim the benefit under Title 35, United States Code, § 120 of any United States application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code, § 112, I acknowledge the duty to disclose all information known to me to be material to patentability of the subject matter claimed in this application, as "materiality" is defined in Title 37, Code of Federal Regulations, § 1.56, which become available between the filing date of the prior application and the national or PCT international filing date of this application:

(Application Serial No.) (Filing Date) (Status)

(Application Serial No.)	(Filing Date)	(Status)
1	1/1/2020	Pending
2	2/1/2020	Granted
3	3/1/2020	Granted
4	4/1/2020	Granted
5	5/1/2020	Granted
6	6/1/2020	Granted
7	7/1/2020	Granted
8	8/1/2020	Granted
9	9/1/2020	Granted
10	10/1/2020	Granted
11	11/1/2020	Granted
12	12/1/2020	Granted
13	1/1/2021	Granted
14	2/1/2021	Granted
15	3/1/2021	Granted
16	4/1/2021	Granted
17	5/1/2021	Granted
18	6/1/2021	Granted
19	7/1/2021	Granted
20	8/1/2021	Granted
21	9/1/2021	Granted
22	10/1/2021	Granted
23	11/1/2021	Granted
24	12/1/2021	Granted
25	1/1/2022	Granted
26	2/1/2022	Granted
27	3/1/2022	Granted
28	4/1/2022	Granted
29	5/1/2022	Granted
30	6/1/2022	Granted
31	7/1/2022	Granted
32	8/1/2022	Granted
33	9/1/2022	Granted
34	10/1/2022	Granted
35	11/1/2022	Granted
36	12/1/2022	Granted
37	1/1/2023	Granted
38	2/1/2023	Granted
39	3/1/2023	Granted
40	4/1/2023	Granted
41	5/1/2023	Granted
42	6/1/2023	Granted
43	7/1/2023	Granted
44	8/1/2023	Granted
45	9/1/2023	Granted
46	10/1/2023	Granted
47	11/1/2023	Granted
48	12/1/2023	Granted
49	1/1/2024	Granted
50	2/1/2024	Granted
51	3/1/2024	Granted
52	4/1/2024	Granted
53	5/1/2024	Granted
54	6/1/2024	Granted
55	7/1/2024	Granted
56	8/1/2024	Granted
57	9/1/2024	Granted
58	10/1/2024	Granted
59	11/1/2024	Granted
60	12/1/2024	Granted
61	1/1/2025	Granted
62	2/1/2025	Granted
63	3/1/2025	Granted
64	4/1/2025	Granted
65	5/1/2025	Granted
66	6/1/2025	Granted
67	7/1/2025	Granted
68	8/1/2025	Granted
69	9/1/2025	Granted
70	10/1/2025	Granted
71	11/1/2025	Granted
72	12/1/2025	Granted
73	1/1/2026	Granted
74	2/1/2026	Granted
75	3/1/2026	Granted
76	4/1/2026	Granted
77	5/1/2026	Granted
78	6/1/2026	Granted
79	7/1/2026	Granted
80	8/1/2026	Granted
81	9/1/2026	Granted
82	10/1/2026	Granted
83	11/1/2026	Granted
84	12/1/2026	Granted
85	1/1/2027	Granted
86	2/1/2027	Granted
87	3/1/2027	Granted
88	4/1/2027	Granted
89	5/1/2027	Granted
90	6/1/2027	Granted
91	7/1/2027	Granted
92	8/1/2027	Granted
93	9/1/2027	Granted
94	10/1/2027	Granted
95	11/1/2027	Granted
96	12/1/2027	Granted
97	1/1/2028	Granted
98	2/1/2028	Granted
99	3/1/2028	Granted
100	4/1/2028	Granted
101	5/1/2028	Granted
102	6/1/2028	Granted
103	7/1/2028	Granted
104	8/1/2028	Granted
105	9/1/2028	Granted
106	10/1/2028	Granted
107	11/1/2028	Granted
108	12/1/2028	Granted
109	1/1/2029	Granted
110	2/1/2029	Granted
111	3/1/2029	Granted
112	4/1/202	

I hereby direct that all correspondence and telephone calls be addressed to Daniel J. Chalker, Gardere Wynne Sewell LLP, 1601 Elm Street, Suite 3000, Dallas, Texas 75201-4761, (214) 999-3000.

I hereby declare that all statements made of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

First Inventor's Full Name:	<u>James</u>	<u>P.</u>	<u>Whitney, III</u>
	(First)	(Initial)	(Last)

Inventor's Signature: _____

Date: _____ Country of Citizenship: (USA)

Residence Address: 4011 Highknoll Lane
Seabrook, Texas 77856
(Include number, street name, city, state, and country)

Post Office Address: Same as above
(if different from residence address)